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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent of:
Saini et al.

Application Serial No.: 10/799,836

Filed: 03/12/2004

For: Compact Microcolumn for
Automated Assembly

§ Customer Number: 000027683
§
§ Issued Patent No.: 7,081,630
§
§ Issued: 07/25/2006
§
§ Docket Number: 34003.110
§

SUBMISSION OF DOCUMENTS UNDER 37 CFR 1.501

Commissioner For Patents
PO Box 1450
Alexandria, VA 22313-1450

Dear Sir:

The undersigned herewith submits in the above-identified patent the references (including a copy of the non-patent literature and foreign patent documents) listed on the attached PTO-1449 form. These documents are pertinent and applicable to the patent and may have a bearing on the patentability thereof on the basis that the documents were cited in pending United States patent applications.

Respectfully submitted,

Dated: 3 AUGUST 2006
HAYNES AND BOONE, LLP
901 Main Street, Suite 3100
Dallas, Texas 75202-3789
Telephone: [214] 651-5533
Facsimile: [214] 200-0853
R115125.1

David L. McCombs
Registration Number 32,271
Attorney for Patentee

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In place of
PTO-1449
Form

U. S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

Complete if Known

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**

(use as many sheets as necessary)

Application Number	10/799,836 (USP 7,081,630)
Filing Date	03/12/2004 (Issued: 07/25/2006)
Applicant(s)	Saini et al.
Art Unit	2881
Examiner Name	Smith, Johnnie L.
Attorney Docket Number	34003.110

SHEET 1 OF 3

U. S. PATENT DOCUMENTS

Examiner's Initials	Cite No.	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
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Examiner
Signature

Date
Considered

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.

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Customer No. 000027683

In place of PTO-1449 Form		U. S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		Complete if Known	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>				Application Number	10/799,836 (USP 7,081,630)
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				Art Unit	2881
				Examiner Name	Smith, Johnnie L.
SHEET	3	OF	3	Attorney Docket Number	34003.110

NON-PATENT LITERATURE DOCUMENTS

Examiner's Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article, title of the item, date, page(s), volume- issue number(s), publisher, city/country where published
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Examiner Signature		Date Considered	
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